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DESCRIPTION

The MP2635 is a highly-integrated, flexible, switch-mode battery charge management and system power path management device for a single-cell Li-ion and Li-Polymer battery used in a wide range of portable applications.

The MP2635 has two operating modes—charge mode and boost mode—to allow management of system and battery power based on the state of the input.

When input power is present, the device operates in charge mode. It automatically detects the battery voltage and charges the battery in the three phases: trickle current, constant current and constant voltage. Other features include charge termination and auto-recharge. This device also integrates both input current limit and input voltage regulation in order to manage input power and meet the priority of the system power demand.

In the absence of an input source, the MP2635 switches to boost mode through the MODE pin to power the SYS pins from the battery. The OLIM pin programs the output current limit in boost mode. The MP2635 also allows an output short-circuit thanks to an output disconnect feature, and can auto-recover when the short circuit fault is removed.

The MP2635 provides full operating status indication to distinguish charge mode from boost mode.

The MP2635 achieves low EMI/EMC performance with well-controlled switching edges.

To guarantee safe operation, the MP2635 limits the die temperature to a preset value 120°C. Other safety features include input over-voltage protection, battery over-voltage protection, thermal shutdown, battery temperature monitoring, and a programmable timer to prevent prolonged charging of a dead battery.

The MP2635 has two battery full options. MP2635: 4.2V/3.6V; MP2635B: 4.35V/4.2V.

FEATURES

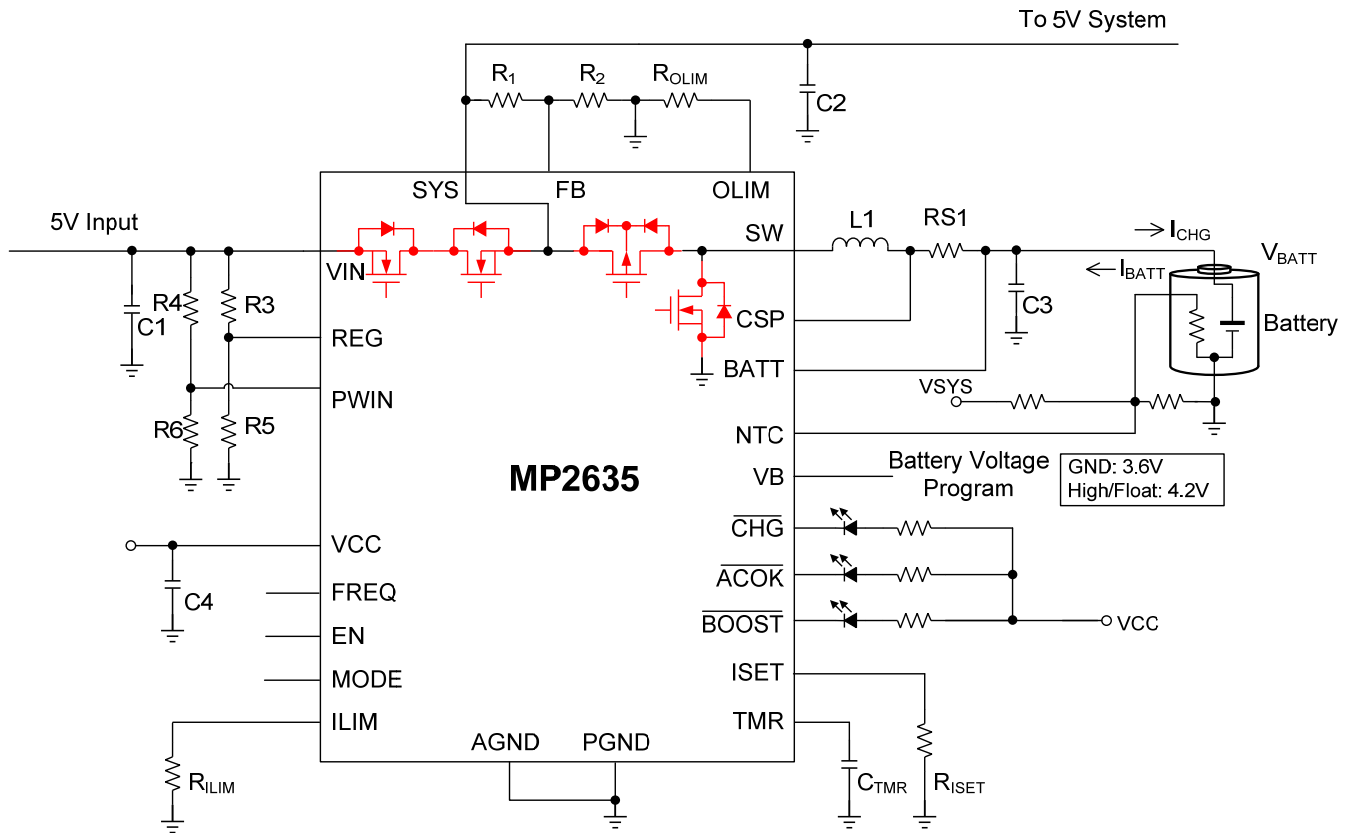
- 4.5V-to-6V Operating Input Voltage Range
- Power Management Function Integrated Input-Current Limit and Input-Voltage Regulation
- Up to 2A Programmable Charge Current
- Trickle-Charge Function
- Selectable Charge Voltage with 0.5% Accuracy: 3.6V/4.2V(MP2635) or 4.35V/4.2V(MP2635B)
- Negative Temperature Coefficient Pin for Battery Temperature Monitoring
- Programmable Timer Back-Up Protection
- Thermal Regulation and Thermal Shutdown
- Internal Battery Reverse Leakage Blocking
- Reverse Boost Operation Mode for System Power
- Up to 91% 5V Boost Mode Efficiency @ 1A
- Programmable Output Current Limit for Boost Mode
- Integrated Short Circuit Protection for Boost Mode

APPLICATIONS

- Sub-Battery Applications
- Power-Bank Applications for Smart-Phone Tablet and Other Portable Devices

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TYPICAL APPLICATION

Table 1: Operation Mode

Power Source	ACOK	EN	MODE	Operating Mode
$0.8V < PWIN < 1.15V$ & $V_{IN} > V_{BATT} + 300mV$	Low	High	X	Charge Mode, Enable Charging
		Low		Charge Mode, Disable Charging
$PWIN < 0.8V$ or $PWIN > 1.15V$ or $V_{IN} < V_{BATT} + 300mV$	High	X	High	Boost Mode
$V_{IN} < 2V$	High	X	Low	Sleep Mode

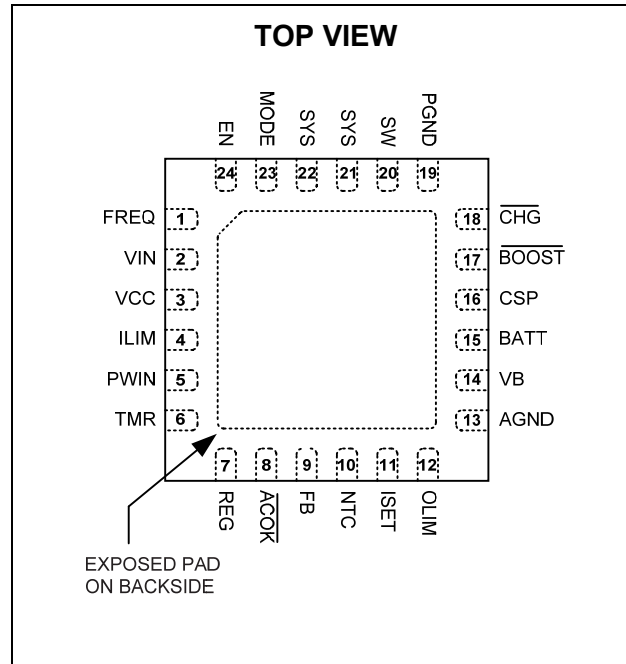
X=Don't Care.

ORDERING INFORMATION

Part Number*	Battery Full Voltage	Package	Top Marking
MP2635GR	4.2V (VB=logic high/float) or 3.6V (VB=GND)	QFN-24 (4mm×4mm)	M2635E
MP2635BGR	4.2V (VB=logic high/float) or 4.35V (VB=GND)	QFN-24 (4mm×4mm)	M2635B

* For Tape & Reel, add suffix -Z (e.g. MP2635GR-Z, MP2635BGR-Z);

PACKAGE REFERENCE



ABSOLUTE MAXIMUM RATINGS ⁽¹⁾

VIN	-0.3V to 20V
SYS	-0.3V to 6.5V
SW	-0.3V (-2V for <20ns) to 6.5V (8.5V for <20ns)
BATT	-0.3V to 6.5V
ACOK, CHG, BOOST	-0.3V to 6.5V
All Other Pins	-0.3V to 6.5V
Junction Temperature	150°C
Lead Temperature	260°C
Continuous Power Dissipation (T _A = +25°C) ⁽²⁾	2.97W
Junction Temperature	150°C
Operating Temperature	-20°C to +85°C

Recommended Operating Conditions ⁽³⁾

Supply Voltage VIN	4.5V to 6V
Battery Voltage V _{OUT}	2.5V to 4.35V
Operating Junction Temp. (T _J)	-40°C to +125°C

Thermal Resistance ⁽⁴⁾	θ_{JA}	θ_{JC}
QFN-24 (4mm×4mm)	42	9 ... °C/W

Notes:

- Exceeding these ratings may damage the device.
- The maximum allowable power dissipation is a function of the maximum junction temperature T_J (MAX), the junction-to-ambient thermal resistance θ_{JA} , and the ambient temperature T_A. The maximum allowable continuous power dissipation at any ambient temperature is calculated by P_D (MAX) = (T_J (MAX)-T_A)/ θ_{JA} . Exceeding the maximum allowable power dissipation will cause excessive die temperature, and the regulator will go into thermal shutdown. Internal thermal shutdown circuitry protects the device from permanent damage.
- The device is not guaranteed to function outside of its operating conditions.
- Measured on JESD51-7, 4-layer PCB.

ELECTRICAL CHARACTERISTICS

$V_{IN} = 5.0V$, $T_A = 25^{\circ}C$, unless otherwise noted.

Parameter	Symbol	Condition	Min	Typ	Max	Units	
IN to SYS NMOS ON Resistance	$R_{IN\ to\ SYS}$			100		m Ω	
High-side PMOS ON Resistance	$R_{H\ DS}$			72		m Ω	
Low-side NMOS ON Resistance	$R_{L\ DS}$			70		m Ω	
High-Side PMOS Peak Current Limit	I_{PEAK_HS}	CC Charge Mode/ Boost Mode		4		A	
		TC Charge Mode		1.5		A	
Low-Side NMOS Peak Current Limit	I_{PEAK_LS}			4.5		A	
Switching Frequency	f_{sw}	FREQ = 0		600		kHz	
		FREQ = Float/ High		1200			
VCC UVLO	$V_{CC\ UVLO}$		2	2.2	2.4	V	
VCC UVLO Hysteresis				100		mV	
PWIN Lower Threshold	$V_{PWIN\ L}$		0.75	0.8	0.85	V	
Lower Threshold Hysteresis				40		mV	
PWIN Upper Threshold	$V_{PWIN\ H}$		1.1	1.15	1.2	V	
Upper Threshold Hysteresis				65		mV	
Charge Mode							
Input Quiescent Current	I_{IN}	EN = 5V, Battery Float			2.5	mA	
		EN = 0			1.5	mA	
Input Current Limit	I_{IN_LIMIT}	$R_{ILIM} = 90.9k$	400	450	500	mA	
		$R_{ILIM} = 49.9k$	720	810	900		
		$R_{ILIM} = 15k$	2400	2700	3000		
Input Over-Current Threshold	$I_{IN(OCPI)}$			3		A	
Input Over-Current Blanking Time ⁽⁵⁾	$T_{INOCBLK}$			120		μs	
Input Over-Current Recover Time ⁽⁵⁾	$T_{INRECVR}$			100		ms	
Terminal Battery Voltage	V_{BATT_FULL}	MP2635	VB=GND	3.582	3.6	3.618	V
			VB=floating or logic HIGH	4.179	4.2	4.221	
		MP2635B	VB= floating or logic HIGH	4.179	4.2	4.221	
			VB=GND	4.328	4.35	4.372	
Recharge Threshold	V_{RECH}	MP2635	VB=GND	3.39	3.44	3.49	V
			VB=floating or logic HIGH	3.95	4.01	4.07	
		MP2635B	VB= floating or logic HIGH	3.95	4.01	4.07	
			VB=GND	4.091	4.153	4.215	

ELECTRICAL CHARACTERISTICS (continued)
 $V_{IN} = 5.0V$, $T_A = 25^\circ C$, unless otherwise noted.

Parameter	Symbol	Condition	Min	Typ	Max	Units	
Recharge Threshold Hysteresis				200		mV	
Battery Over Voltage Threshold				103.3%		V_{BATT_FULL}	
Constant Charge (CC) Current	I_{CC}	$RS1 = 40m\Omega$, $R_{ISET} = 69.8k$	900	1000	1100	mA	
		$RS1 = 40m\Omega$, $R_{ISET} = 34.9k$	1800	2000	2200		
Trickle Charge Current	I_{TC}			230		mA	
Trickle Charge Voltage Threshold	V_{BATT_TC}	MP2635	VB=GND	2.47	2.57	2.67	V
			VB=floating or logic HIGH	2.9	3	3.1	
		MP2635B	VB=GND	3.003	3.107	3.21	
			VB=floating or logic HIGH	2.9	3	3.1	
Trickle Charge Hysteresis				200		mV	
Termination Charge Current	I_{BF}	$RS1 = 40m\Omega$, $R_{ISET}=69.8k$	2.5%	10%	17.5%	I_{CC}	
		$RS1 = 40m\Omega$, $R_{ISET}=34.9k$	5%	10%	15%	I_{CC}	
Input-Voltage-Regulation Reference	V_{REG}		1.18	1.2	1.22	V	
Boost Mode							
SYS Voltage Range			4.2		5.6	V	
Feedback Voltage			1.18	1.2	1.22	V	
Feedback Input Current		$V_{FB}=1V$			200	nA	
Boost SYS Over-Voltage Protection Threshold	$V_{SYS(OVP)}$	Threshold over V_{SYS} to turn off the converter during boost mode	5.8	6	6.2	V	
SYS Over Voltage Protection Threshold Hysteresis		V_{SYS} falling from $V_{SYS(OVP)}$		125		mV	
Boost Quiescent Current		$I_{SYS} = 0$, MODE = 5V			1.4	mA	
Programmable Boost Output Current Limit Accuracy	I_{OLIM}	$RS1 = 40m\Omega$, $R_{OLIM} = 100k$	0.896	1.12	1.344	A	
Programmable Boost Output Current ⁽⁵⁾		$RS1 = 50m\Omega$, $R_{OLIM} = 59k$	1.5			A	
SYS Over-Current Blanking Time ⁽⁵⁾	$T_{SYSOCBLK}$			120		μs	
SYS Over-Current Recover Time ⁽⁵⁾	$T_{SYSRECVR}$			1		ms	
Weak-Battery Threshold	$V_{BATT(LOW)}$	During boosting		2.5		V	
		Before Boost starts		2.9	3.05	V	
Sleep Mode							
Battery Leakage Current	$I_{LEAKAGE}$	$V_{BATT} = 4.2V$, SYS Float, $V_{IN} = 0V$, MODE = 0V		15	30	μA	

ELECTRICAL CHARACTERISTICS (continued)
 $V_{IN} = 5.0V$, $T_A = 25^{\circ}C$, unless otherwise noted.

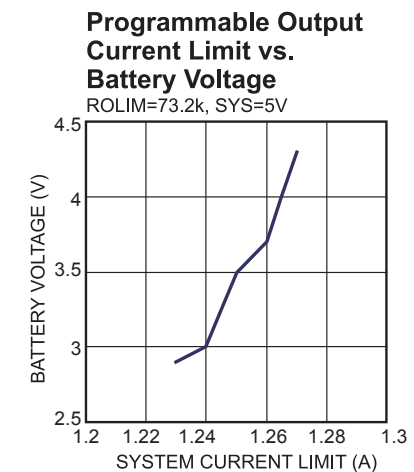
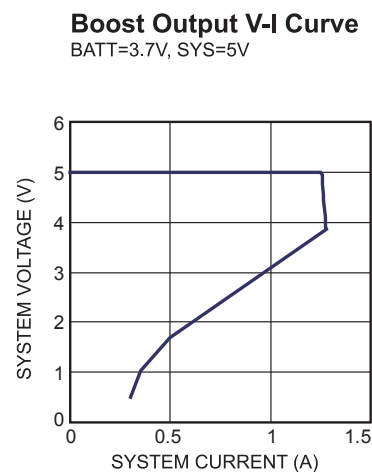
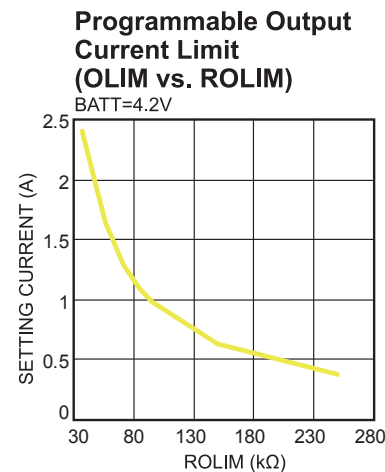
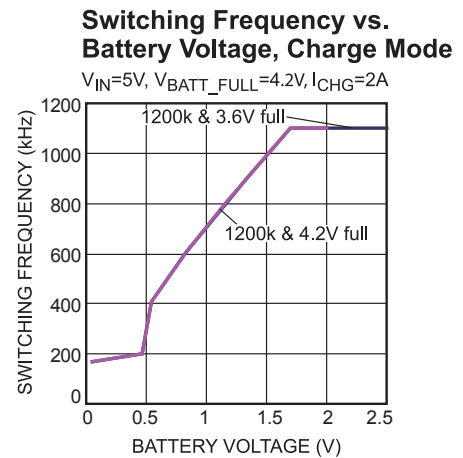
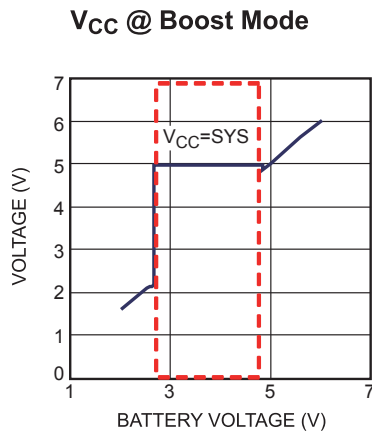
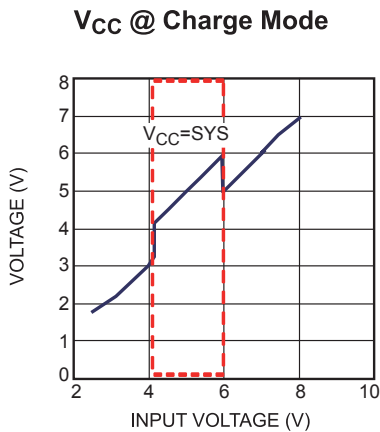
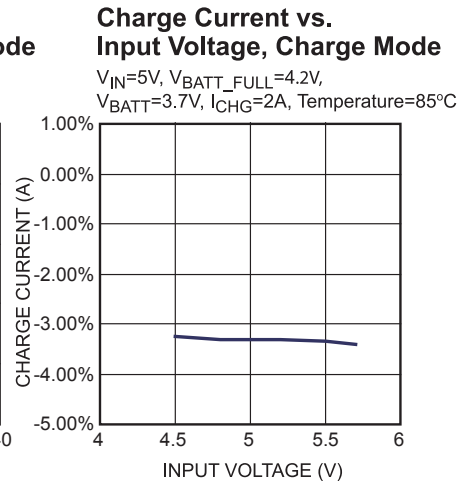
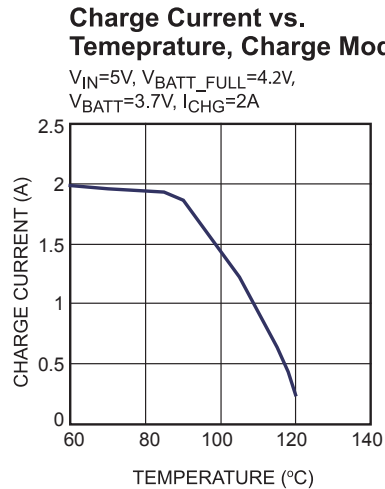
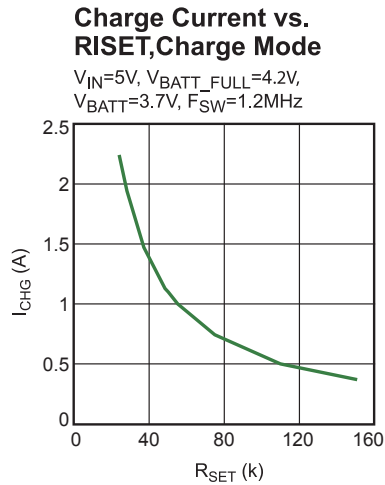
Parameter	Symbol	Condition	Min	Typ	Max	Units	
Indication and Logic							
ACOK, CHG, BOOST pin output low voltage		Sinking 1.5mA			400	mV	
ACOK, CHG, BOOST pin leakage current		Connected to 5V			1	μA	
NTC and Time-out Fault Blinking Frequency ⁽⁵⁾		$C_{TMR} = 0.1\mu F$, $I_{CHG} = 1A$		13.7		Hz	
EN Input Logic Low Voltage					0.4	V	
EN Input High Voltage			1.4			V	
Mode Input Logic Low Voltage					0.4	V	
Mode Input Logic High Voltage			1.4			V	
Protection							
Trickle Charge Time		$C_{TMR}=0.1\mu F$, remains in TC Mode, $I_{CHG}= 1A$		60		Min	
Total Charge Time		$C_{TMR}=0.1\mu F$, $I_{CHG}= 1A$		360		Min	
NTC Low Temp, Rising Threshold		$R_{NTC}=NCP18XH103(0^{\circ}C)$	65%	66%	67%	V_{SYS}	
NTC Low Temp, Rising Threshold Hysteresis				1%			
NTC High Temp, Rising Threshold		$R_{NTC}=NCP18XH103(50^{\circ}C)$	34%	35%	36%		
NTC High Temp, Rising Threshold Hysteresis				1%			
Charging Current Foldback Threshold ⁽⁵⁾		Charge Mode		120			$^{\circ}C$
Thermal Shutdown Threshold ⁽⁵⁾				150			$^{\circ}C$

Notes:

5) Guaranteed by design.

TYPICAL CHARACTERISTICS

MP2635, $C_{IN}=C_{BATT}=C_{SYS}=C_3=22\mu F$, $C_1=C_2=1\mu F$, $L_1=4.7\mu H$, $R_{S1}=50m\Omega$, $C_4=C_{TMR}=0.1\mu F$, Battery Simulator, unless otherwise noted.



TYPICAL PERFORMANCE CHARACTERISTICS

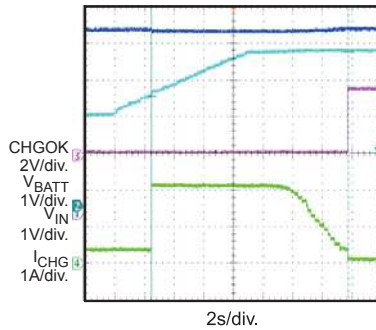
MP2635, For Charge Mode: $V_{IN}=5V$, $I_{CHG}=1.5A$, $L_{IN_LIM}=2.7A$, $I_{SYS}=0A$

For Boost: $BATT=3.7V$, $SYS_SET=5V$, $OLIM=1.4A$

$C_{IN}=C_{BATT}=C_{SYS}=C3=22\mu F$, $C1=C2=1\mu F$, $L1=4.7\mu H$, $RS1=50m\Omega$, $C4=C_{TMR}=0.1\mu F$, $RILIM=15k\Omega$, $RISSET=28k\Omega$, $ROLIM=63.4k\Omega$, $BATT_FULL=4.2V$, $F_S=1.2MHz$, Battery Simulator, unless otherwise noted.

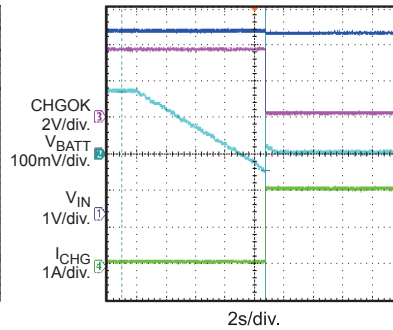
Battery Charge Curve

$V_{BATT_FULL} = 4.2V$



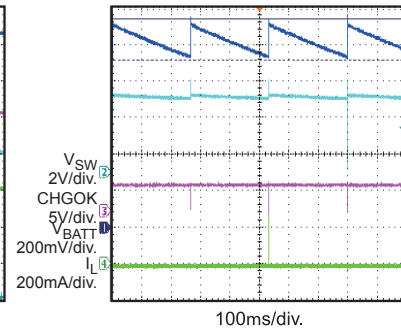
Auto Recharge

$V_{BATT_FULL} = 4.2V$



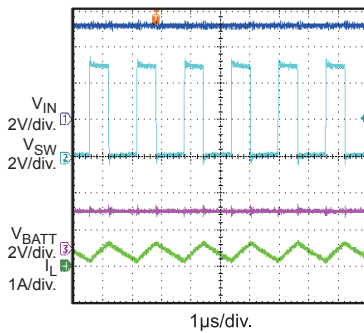
Battery Float Steady State

$V_{BATT_FULL} = 4.2V$



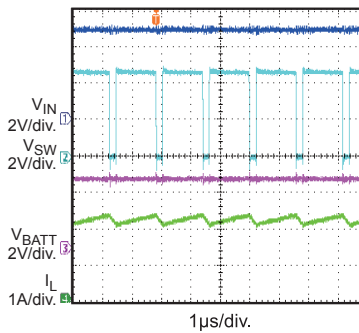
TC Charge Steady State

$V_{BATT_FULL} = 4.2V$, $V_{BATT} = 2V$,
 $F_{SW} = 600kHz$



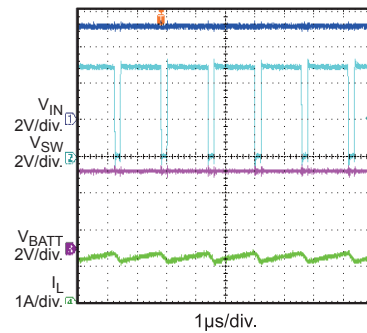
CC Charge Steady State

$V_{BATT_FULL} = 4.2V$, $V_{BATT} = 3.7V$,
 $F_{SW} = 600kHz$



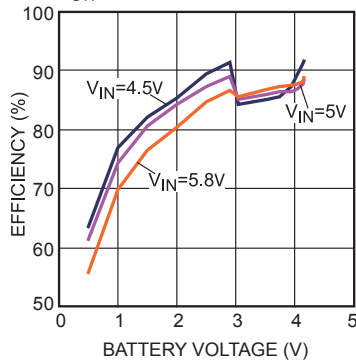
CV Charge Steady State

$V_{BATT_FULL} = 4.2V$, $V_{BATT} = 4.2V$,
 $F_{SW} = 600kHz$



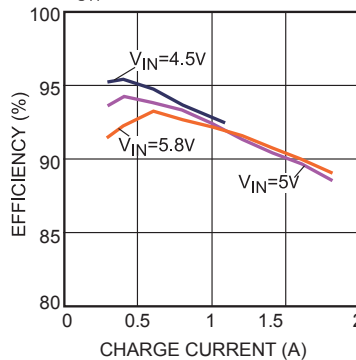
Constant Current Charge Efficiency

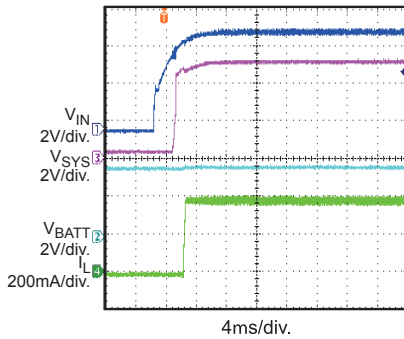
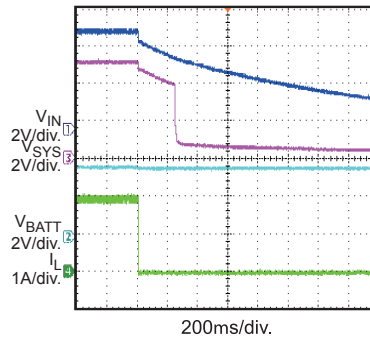
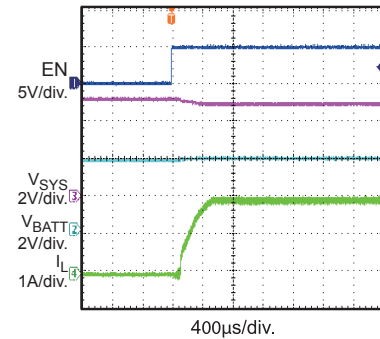
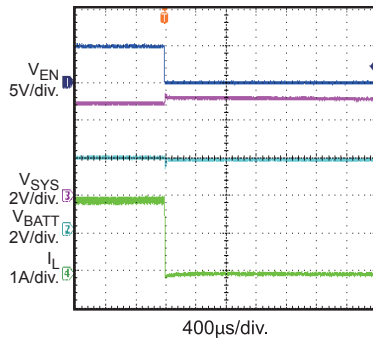
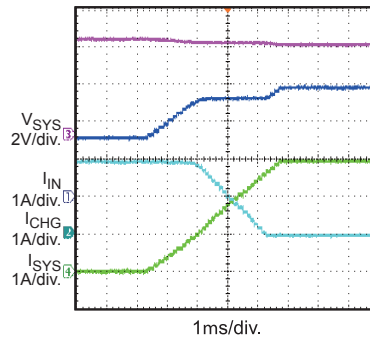
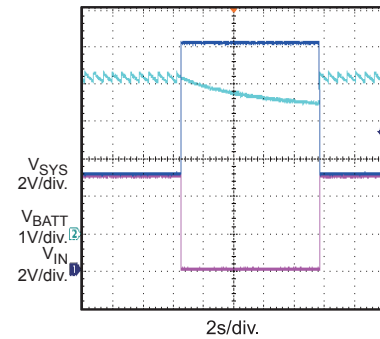
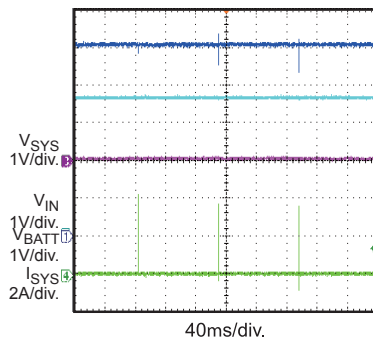
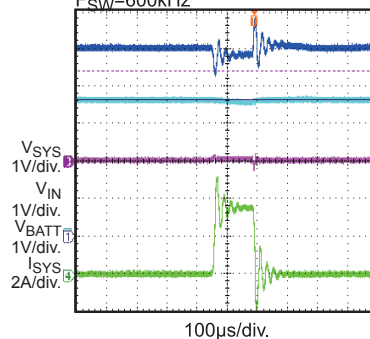
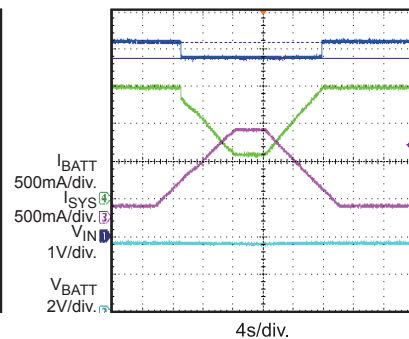
$V_{BATT_FULL} = 4.2V$, $V_{BATT} = 0.5-4.2V$,
 $F_{SW} = 600kHz$

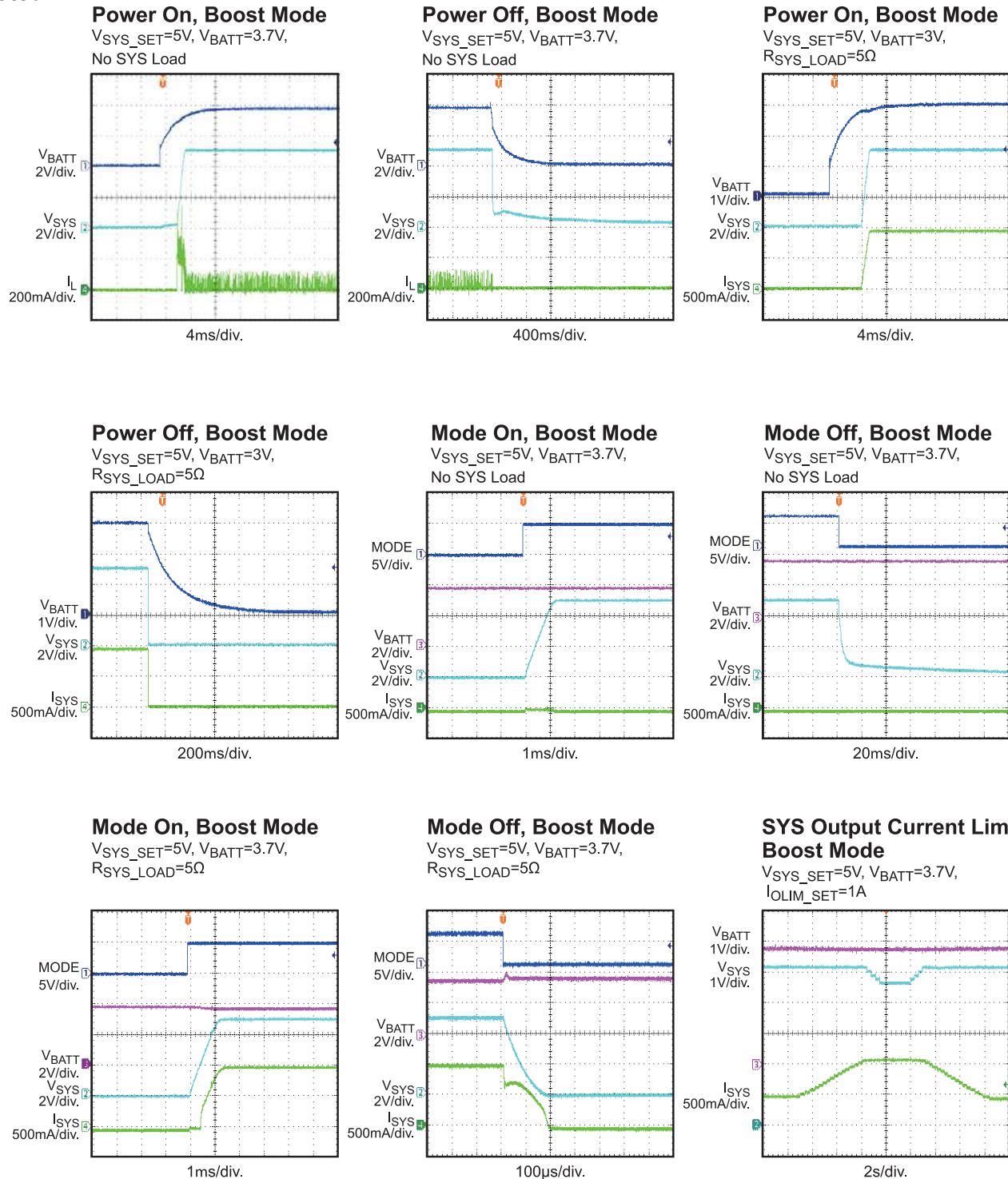


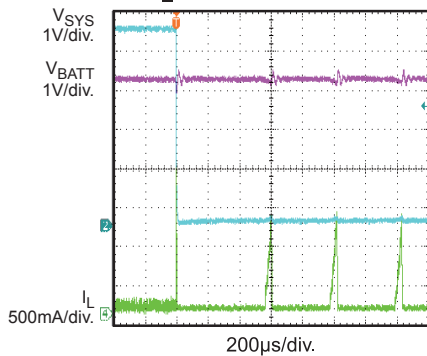
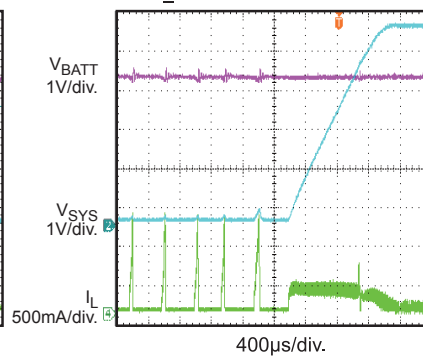
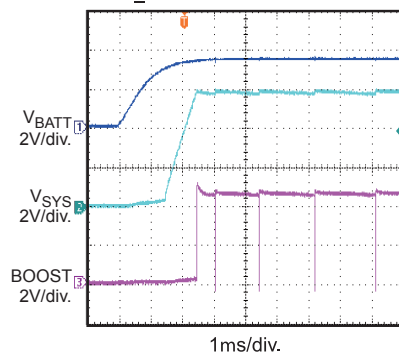
Constant Voltage Charge Efficiency

$V_{BATT_FULL} = 4.2V$, $V_{BATT} = 4.2V$,
 $F_{SW} = 600kHz$

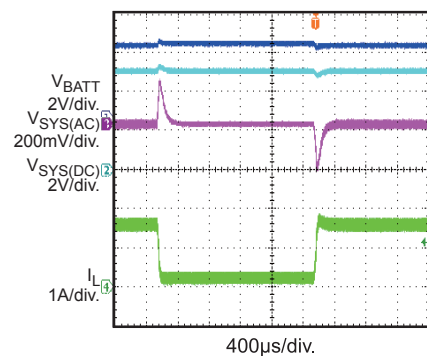
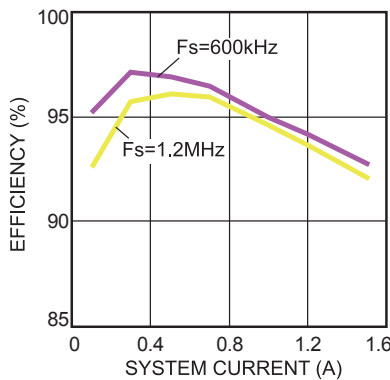
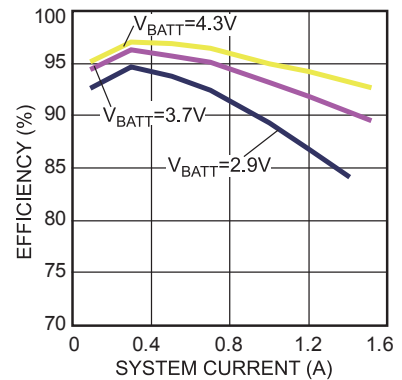


TYPICAL PERFORMANCE CHARACTERISTICS (continued)
MP2635, For Charge Mode: $V_{IN}=5V$, $I_{CHG}=1.5A$, $L_{IN_LIM}=2.7A$, $I_{SYS}=0A$
For Boost: $BATT=3.7V$, $SYS_SET=5V$, $OLIM=1.4A$
 $C_{IN}=C_{BATT}=C_{SYS}=C3=22\mu F$, $C1=C2=1\mu F$, $L1=4.7\mu H$, $RS1=50m\Omega$, $C4=C_{TMR}=0.1\mu F$, $RILIM=15k\Omega$, $RISET=28k\Omega$, $ROLIM=63.4k\Omega$, $BATT_FULL=4.2V$, $F_S=1.2MHz$, Battery Simulator, unless otherwise noted.
Power On, Charge Mode
 $V_{BATT_FULL}=4.2V$, $V_{BATT}=3.7V$,
 $I_{CHG}=2A$

Power Off, Charge Mode
 $V_{BATT_FULL}=4.2V$, $V_{BATT}=3.7V$,
 $I_{CHG}=2A$

En On, Charge Mode
 $V_{BATT_FULL}=4.2V$, $V_{BATT}=3.7V$,
 $I_{CHG}=2A$

En Off, Charge Mode
 $V_{BATT_FULL}=4.2V$, $V_{BATT}=3.7V$,
 $I_{CHG}=2A$

Input Current Limit, Charge Mode
 $V_{BATT_FULL}=4.2V$, $V_{BATT}=3.7V$

Input Over Voltage Protection, Charge Mode
 $V_{IN}=5V$ to $12V$, $R_{SYS_LOAD}=25\Omega$,
 Battery Float, Enabled Charge
 
System Short Protection
 $V_{BATT_FULL}=4.2V$, $V_{BATT}=2V$,
 $F_{SW}=600kHz$

System Short Protection Zoom In
 $V_{BATT_FULL}=4.2V$, $V_{BATT}=2V$,
 $F_{SW}=600kHz$

Input Voltage Clamp @ 4.6V
 $EN=High$, Mode=Low
 

TYPICAL PERFORMANCE CHARACTERISTICS (continued)
MP2635, For Charge Mode: $V_{IN}=5V$, $I_{CHG}=1.5A$, $L_{IN_LIM}=2.7A$, $I_{SYS}=0A$
For Boost: $BATT=3.7V$, $SYS_SET=5V$, $OLIM=1.4A$
 $C_{IN}=C_{BATT}=C_{SYS}=C3=22\mu F$, $C1=C2=1\mu F$, $L1=4.7\mu H$, $RS1=50m\Omega$, $C4=C_{TMR}=0.1\mu F$, $RILIM=15k\Omega$, $RISSET=28k\Omega$, $ROLIM=63.4k\Omega$, $BATT_FULL=4.2V$, $F_s=1.2MHz$, Battery Simulator, unless otherwise noted.


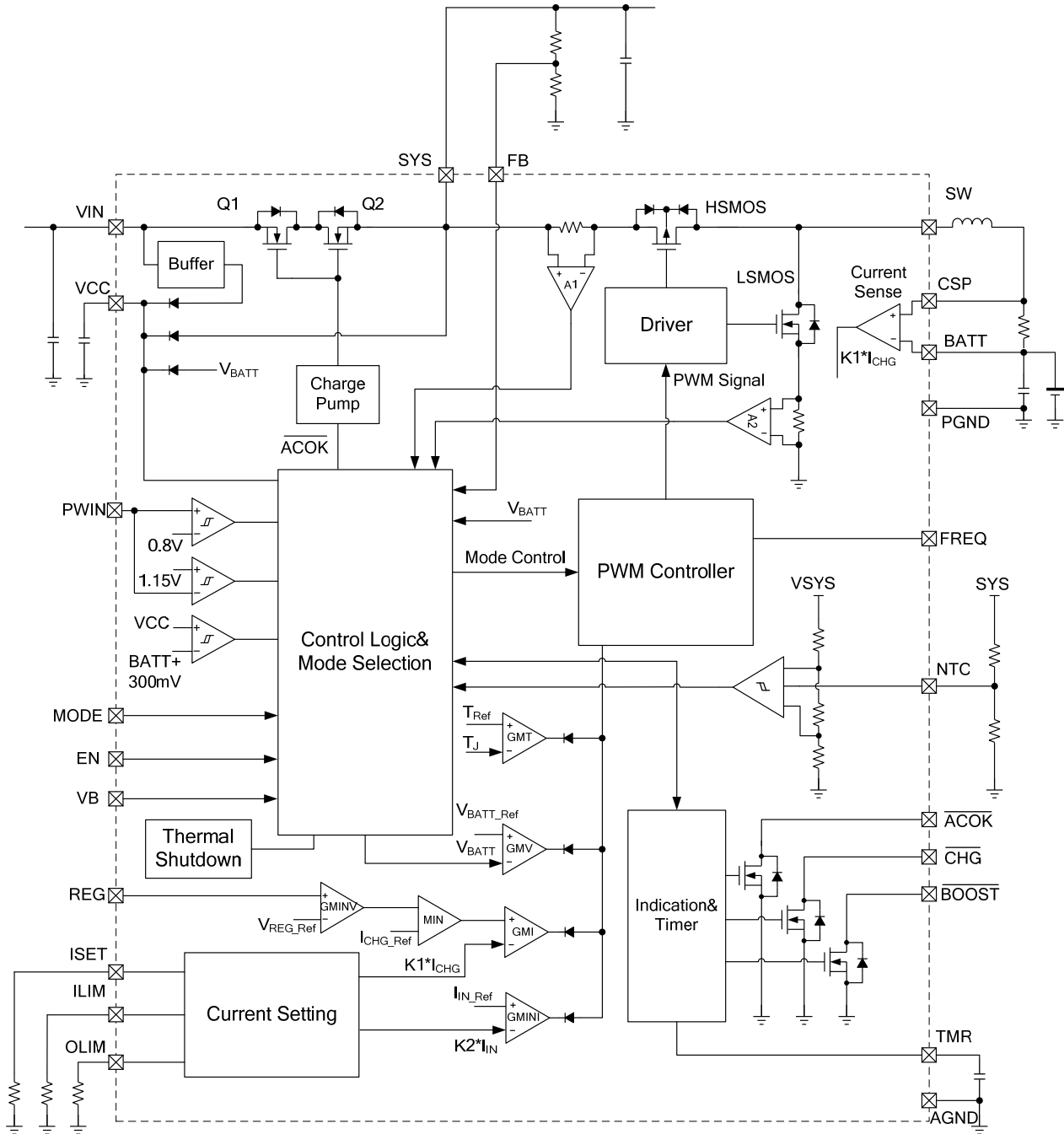
TYPICAL PERFORMANCE CHARACTERISTICS (continued)
MP2635, For Charge Mode: $V_{IN}=5V$, $I_{CHG}=1.5A$, $L_{IN_LIM}=2.7A$, $I_{SYS}=0A$
For Boost: $BATT=3.7V$, $SYS_SET=5V$, $OLIM=1.4A$
 $C_{IN}=C_{BATT}=C_{SYS}=C3=22\mu F$, $C1=C2=1\mu F$, $L1=4.7\mu H$, $RS1=50m\Omega$, $C4=C_{TMR}=0.1\mu F$, $RILIM=15k\Omega$, $RISSET=28k\Omega$, $ROLIM=63.4k\Omega$, $BATT_FULL=4.2V$, $F_s=1.2MHz$, Battery Simulator, unless otherwise noted.
SYS Short Circuit Entry, Boost Mode
 $V_{SYS_SET}=5V$, $V_{BATT}=3.7V$

SYS Short Circuit Recovery, Boost Mode
 $V_{SYS_SET}=5V$, $V_{BATT}=3.7V$

SYS Over Voltage Protection, Boost Mode
 $V_{SYS_SET}=6.5V$, $V_{BATT}=3.7V$

Load Transient Response

EN= Low, Mode= High

 $I_{SYS} = 100mA$ to $1A$ with Slew Rate $2.5A/\mu s$

Boost Efficiency
 $BATT=4.3V$, $SYS=5V$

Boost Efficiency
 $SYS=5V$, $F_s=600kHz$


PIN FUNCTIONS

Pin #	Name	Description
1	FREQ	Connect to GND to program the operating frequency to 600kHz. Leave floating or connect to HIGH to program the operating frequency to 1.2MHz.
2	VIN	Adapter Input. Place a bypass capacitor close to this pin to prevent large input voltage spikes.
3	VCC	Internal Circuit Power Supply. Bypass to GND with a 100nF ceramic capacitor. This pin can not carry external load higher than 5mA.
4	ILIM	Input Current Set. Connect to GND with an external resistor to program input current limit in charge mode.
5	PWIN	AC Input Detect. Detect the presence of valid input power.
6	TMR	Oscillator Period Timer. Connect a timing capacitor between this pin and GND to set the oscillator period. Short to GND to disable the Timer function.
7	REG	Input Voltage Feedback for input voltage regulation loop. Connect to tap of an external resistor divider from VIN to GND to program the input voltage regulation. Once the voltage at REG pin drops to the inner threshold, the charge current is reduced to maintain the input voltage at the regulation value.
8	$\overline{\text{ACOK}}$	Valid Input Supply Indicator. Logic LOW on this pin indicates the presence of a valid power supply.
9	FB	System voltage feedback input.
10	NTC	Negative Temperature Coefficient (NTC) Thermistor.
11	ISET	Charge Current Set. Connect an external resistor to GND to program the charge current.
12	OLIM	Programmable Output-Current Limit for boost mode. Connect an external resistor to GND to program the system current in boost mode.
13	AGND	Analog Ground
14	VB	MP2635 Programmable Battery-Full Voltage. Connect to GND for 3.6V. Leave floating or connect to logic HIGH for 4.2V
		MP2635B Programmable Battery-Full Voltage. Connect to GND for 4.35V. Leave floating or connect to logic HIGH for 4.2V
15	BATT	Positive Battery Terminal / Battery Charge Current Sense Negative Input.
16	CSP	Battery Charge Current Sense Positive Input.
17	$\overline{\text{BOOST}}$	Boost Mode indicator. Logic LOW indicates boost mode in operation. The pin becomes an open drain when the part operates in charge mode or sleep mode.
18	$\overline{\text{CHG}}$	Charge Completion Indicator. Logic LOW indicates charge mode. The pin becomes an open drain once the charging has completed or is suspended.
19	PGND, Exposed Pad	Power Ground. Connect the exposed pad and GND pin to the same ground plane.
20	SW	Switch Output Node.
21, 22	SYS	System Output. Please make sure the enough bulk capacitors from SYS to GND. Suggest 4.7μF at least. The capacitor should be put as close as possible to SYS and GND.
23	MODE	Mode Select. Logic HIGH→boost mode. Logic LOW→sleep mode. Active only when $\overline{\text{ACOK}}$ is HIGH (input power is not available).
24	EN	Charge Control Input. Logic HIGH enables charging. Logic LOW disables charging. Active only when $\overline{\text{ACOK}}$ is low (input power is OK).

BLOCK DIAGRAM

Figure 1: Functional Block Diagram in Charge Mode

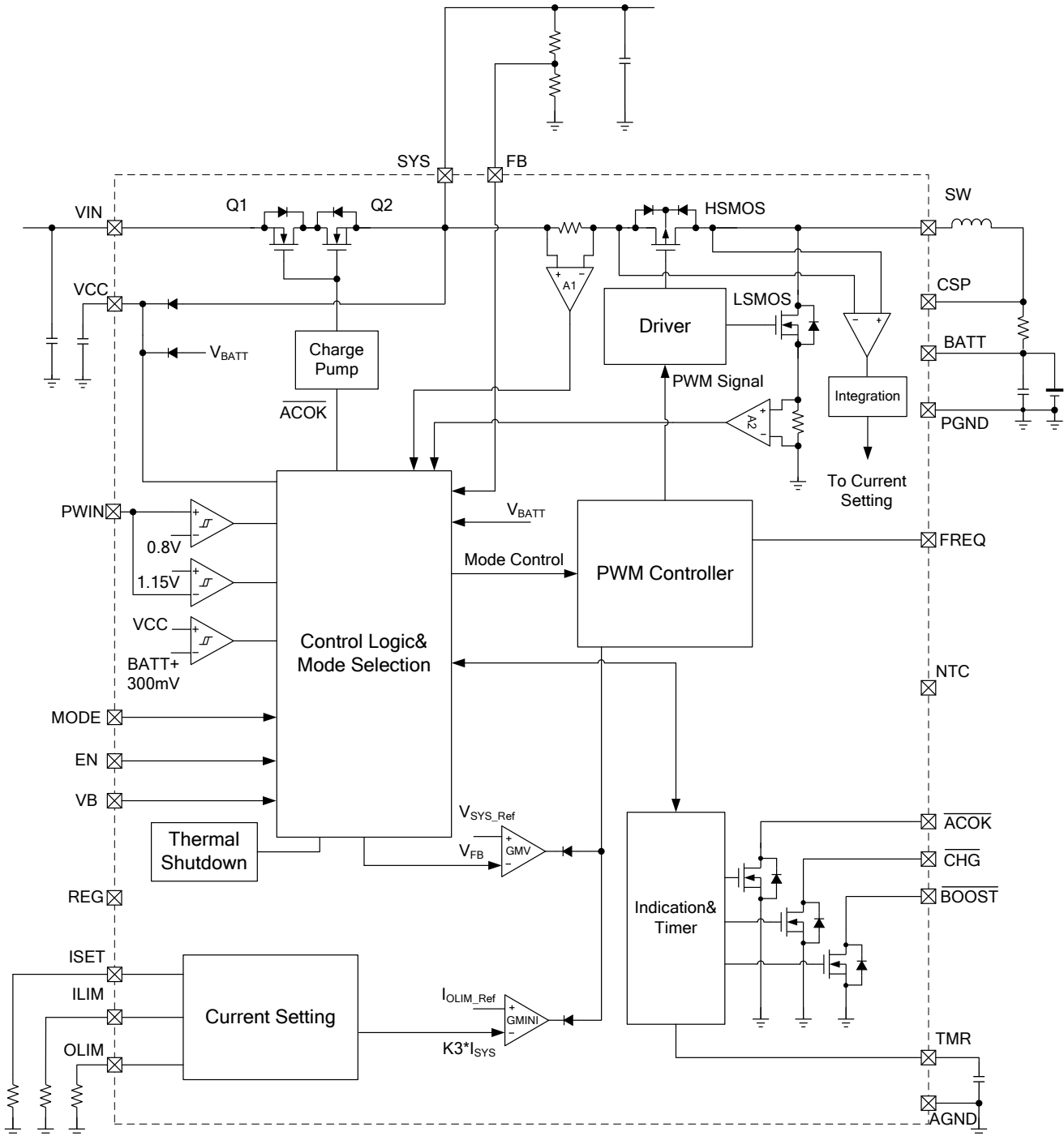


Figure 2: Functional Block Diagram in Boost Mode

OPERATION FLOW CHART

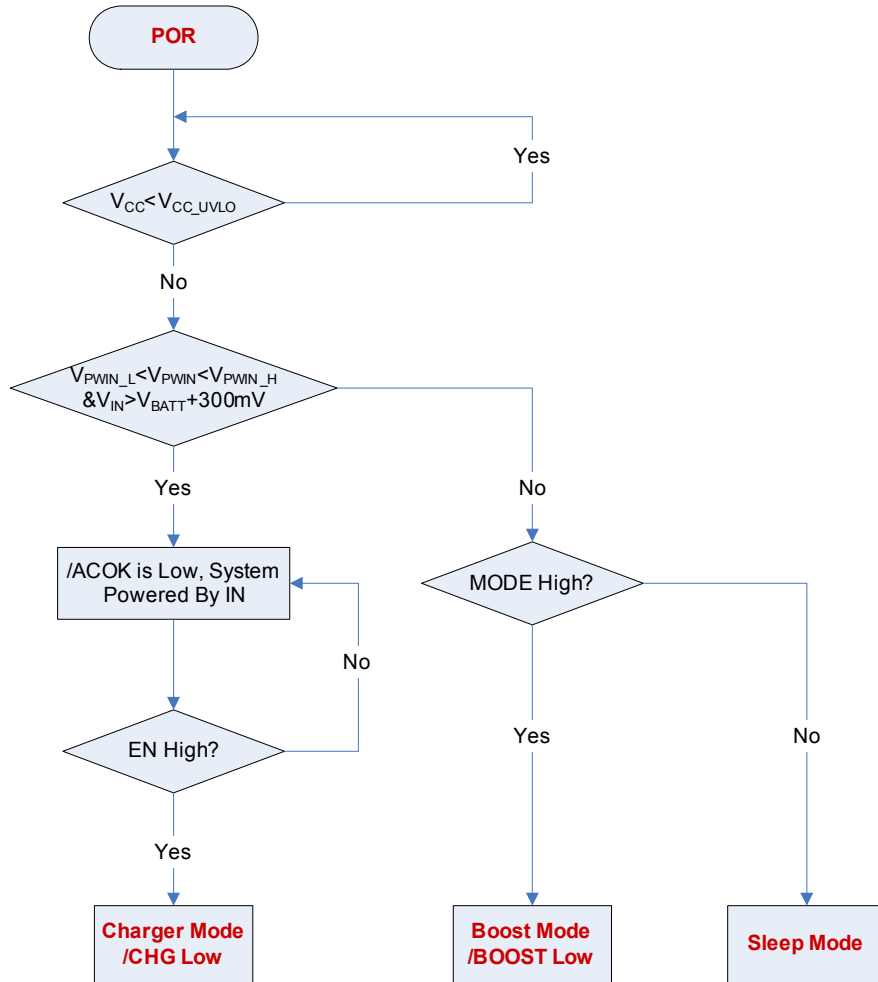


Figure 3: Mode Selection Flow Chart

OPERATION FLOW CHART (continued)

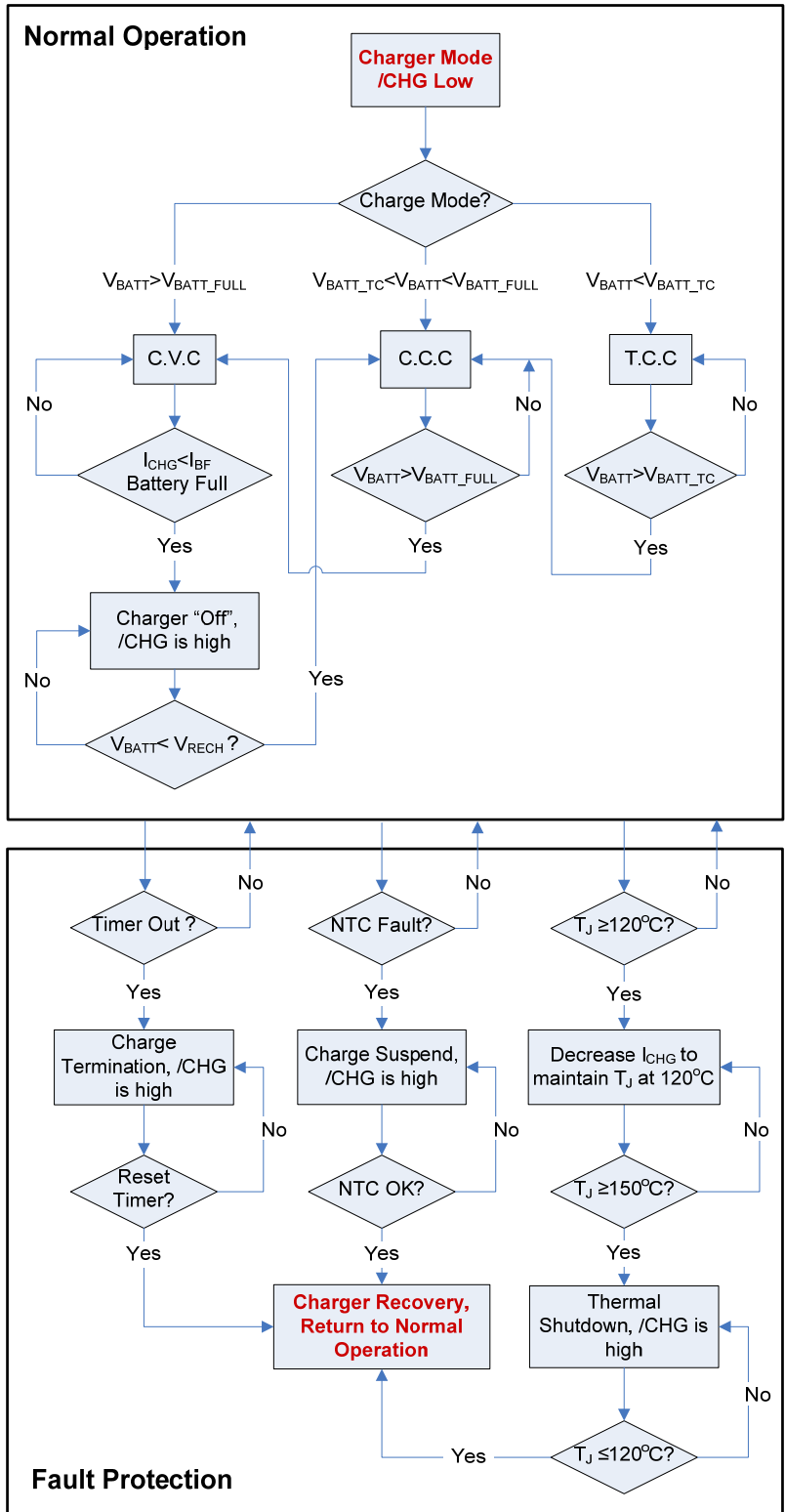


Figure 4: Normal Operation and Fault Protection in Charge Mode

OPERATION FLOW CHART (continued)

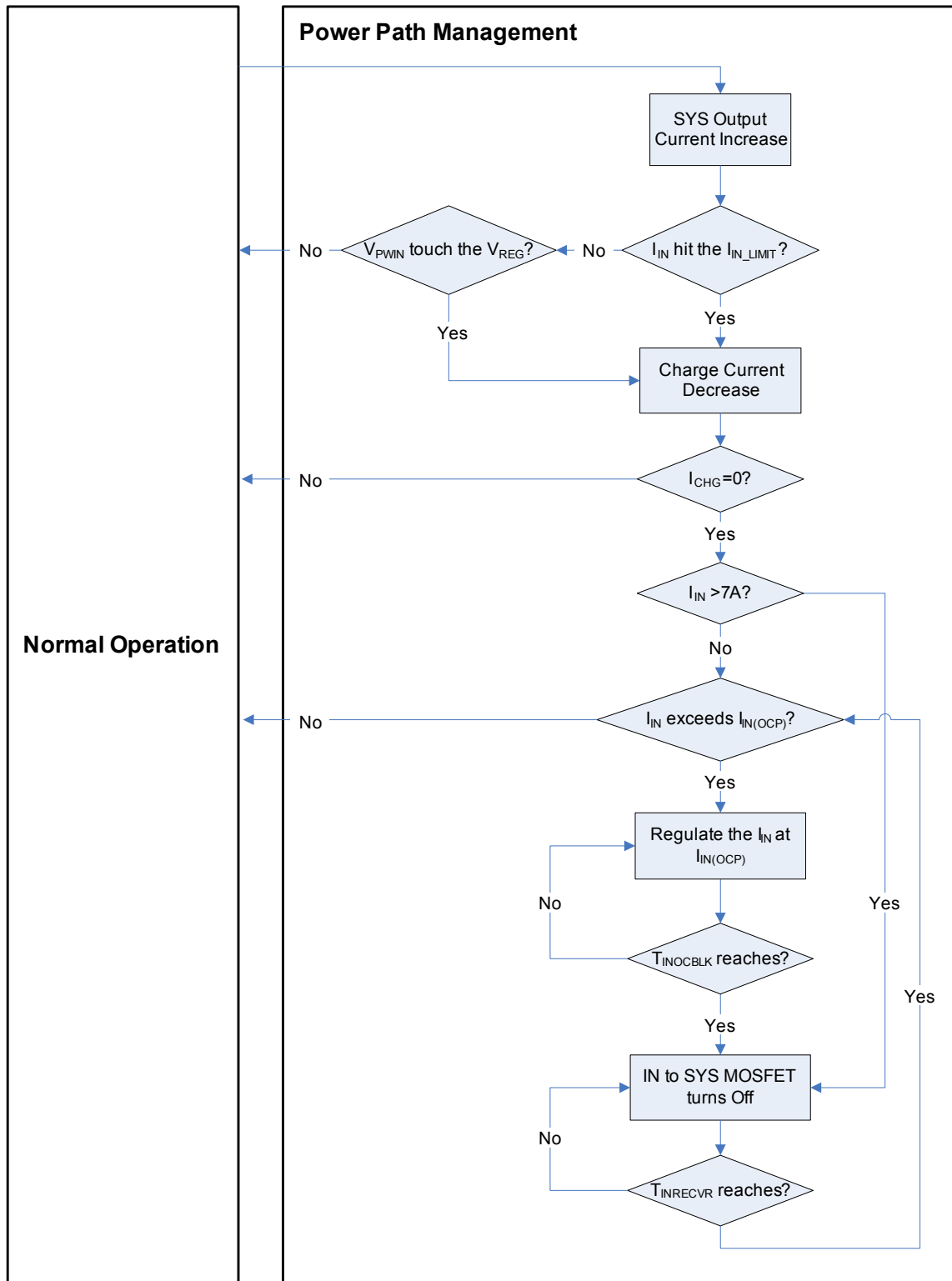


Figure 5: Power-path Management in Charge Mode

OPERATION FLOW CHART (continued)

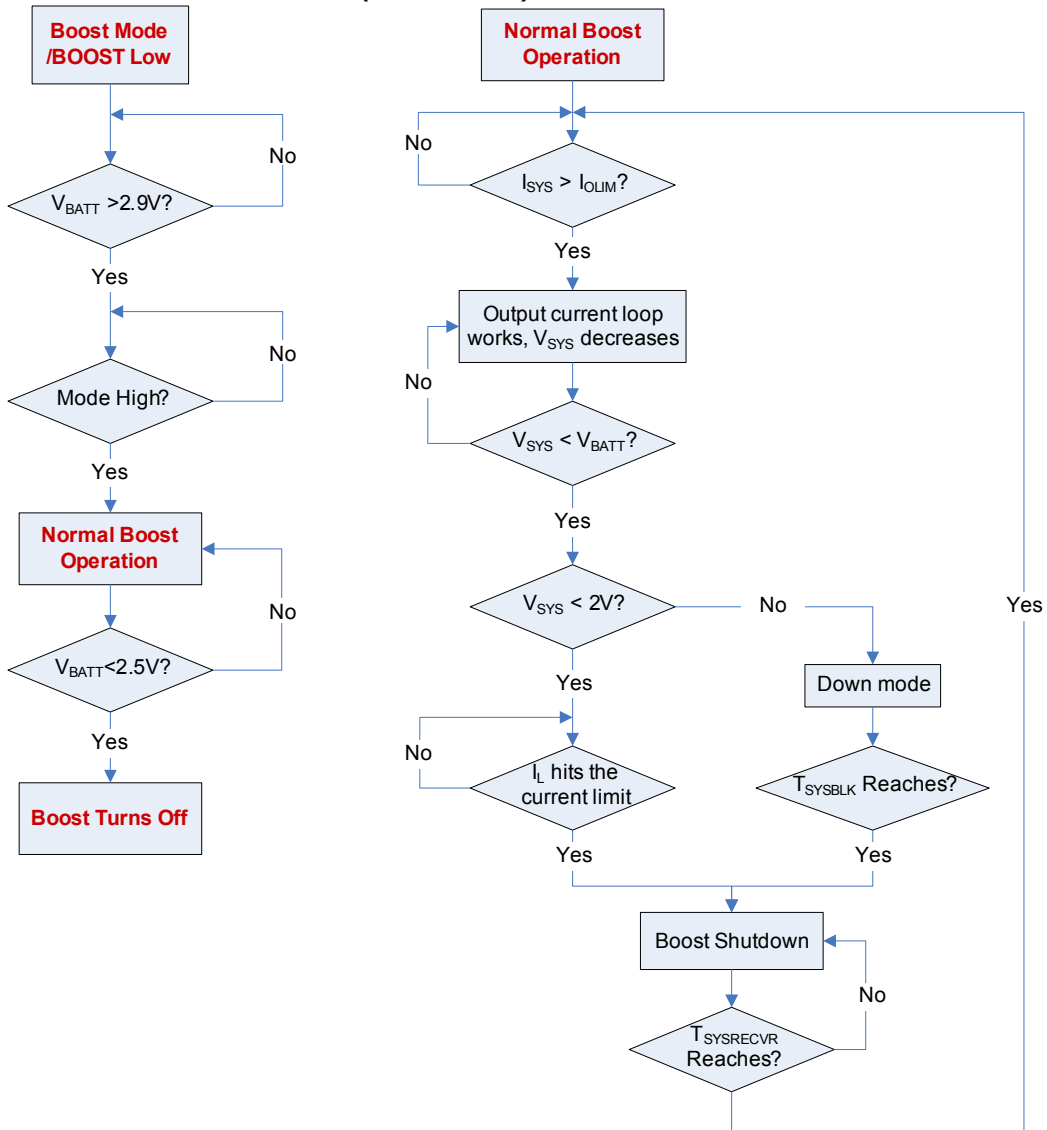


Figure 6: Operation Flow Chart in Boost Mode

START UP TIME FLOW IN CHARGE MODE

Condition: EN = 5V, Mode = 0V, /ACOK and /CHG are always pulled up to an external constant 5V

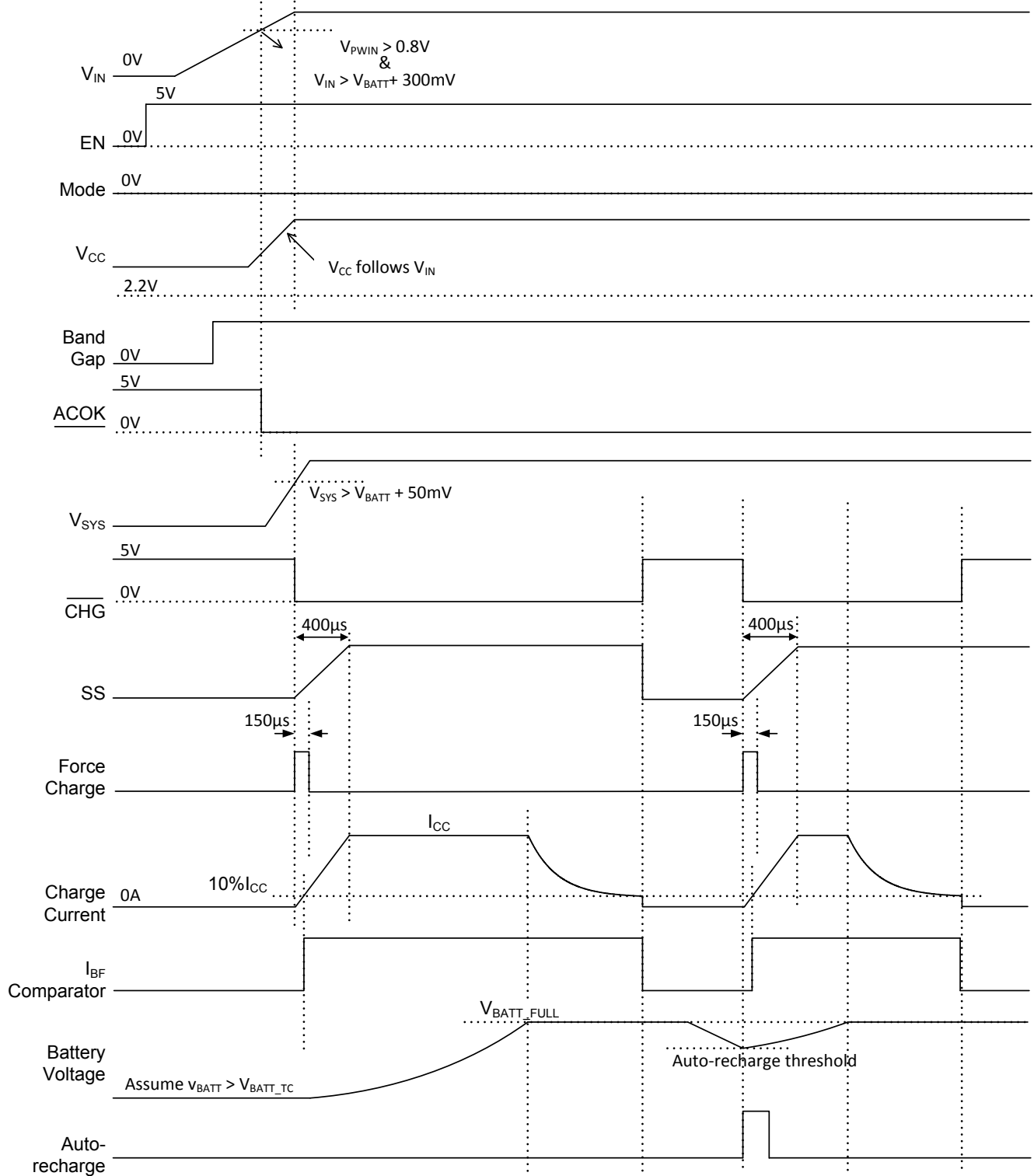


Figure 7: Input Power Start-Up Time Flow in Charge Mode

START UP TIME FLOW IN CHARGE MODE

Condition: $V_{IN} = 5V$, Mode = 0V, /ACOK and /CHG are always pulled up to an external constant 5V.

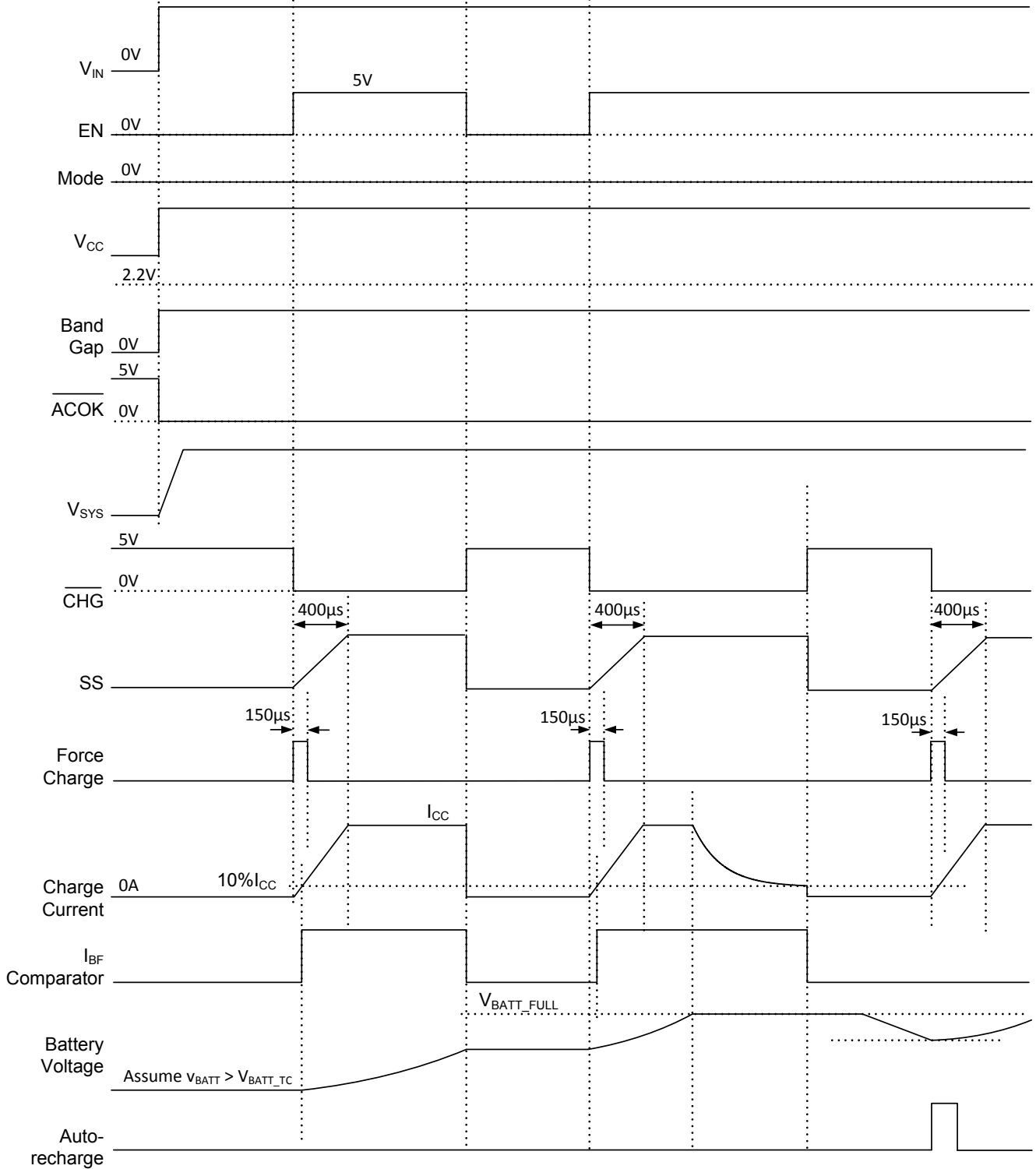


Figure 8: EN Start-Up Time Flow in Charge Mode

START UP TIME FLOW IN BOOST MODE

Condition: $V_{IN} = 0V$, Mode = 5V, /Boost is always pulled up to an external constant 5V.

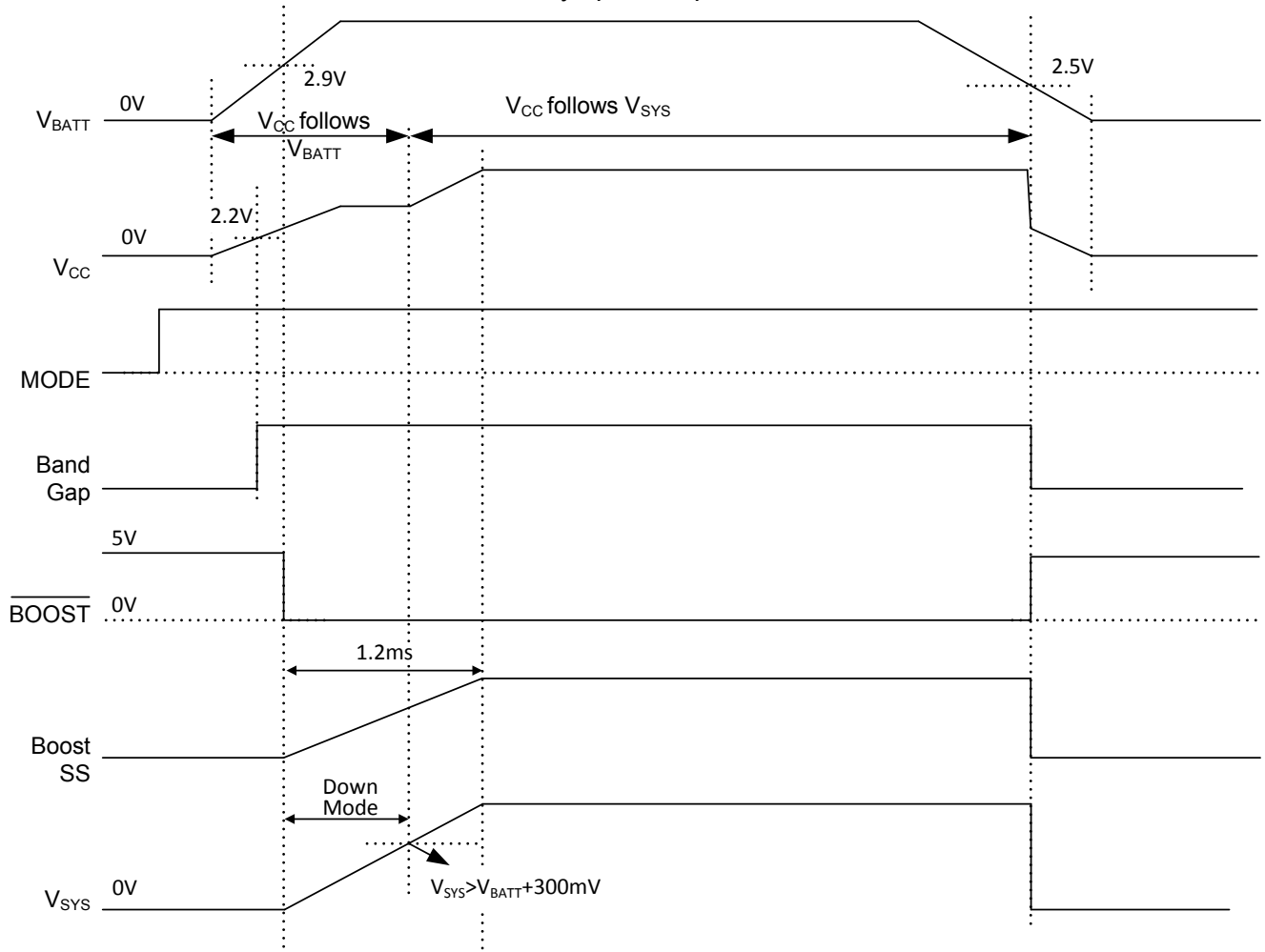


Figure 9: Battery Power Start-Up Time Flow in Boost Mode

START UP TIME FLOW IN BOOST MODE

Condition: $V_{IN} = 0V$, /Boost is always pulled up to an external constant 5V.

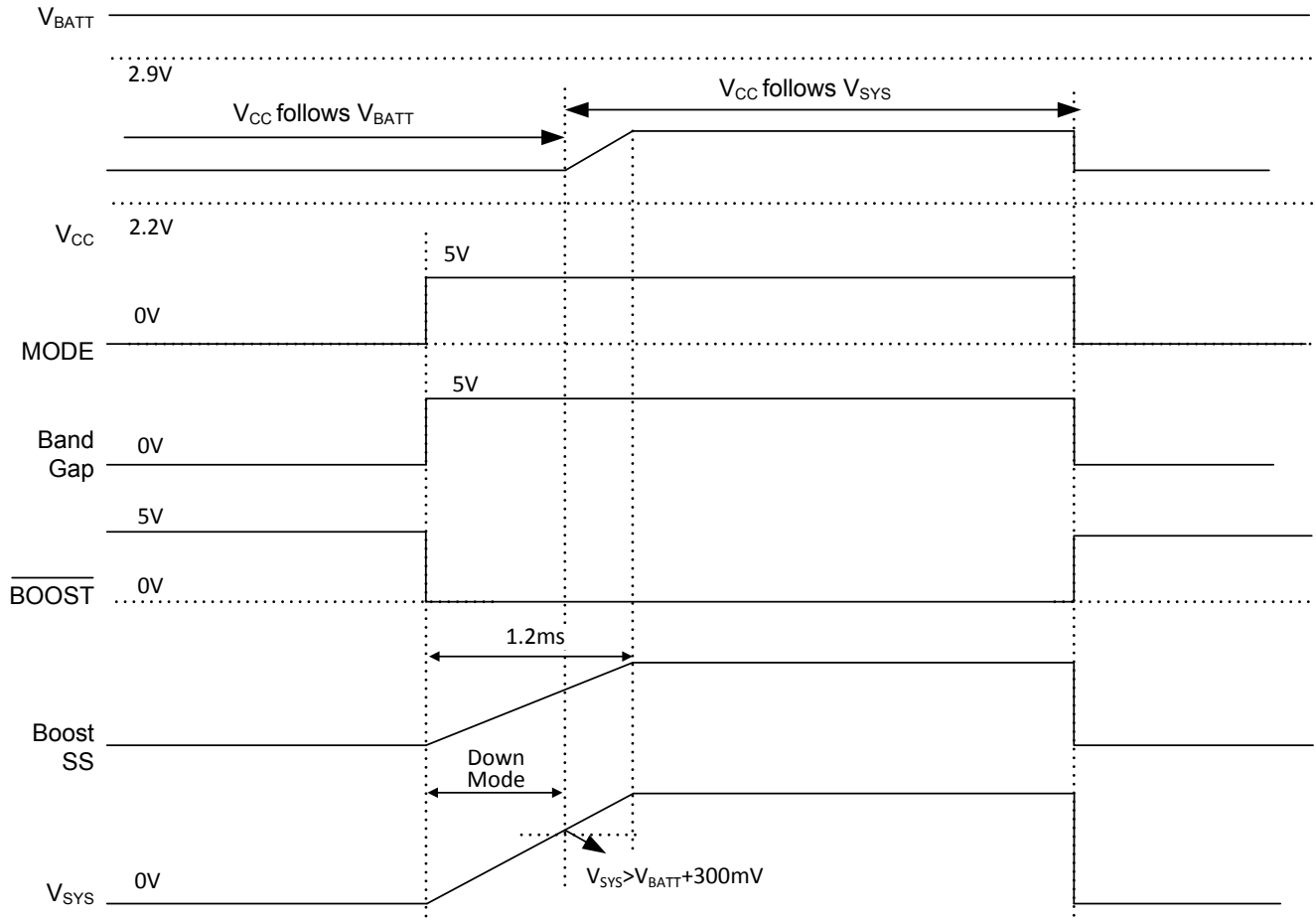


Figure 10: Mode Start-Up Time Flow in Boost Mode

OPERATION

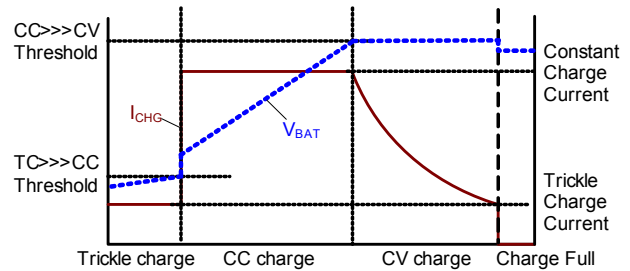
INTRODUCTION

The MP2635 is a highly-integrated, synchronous, switching charger with bi-directional operation for a boost function that can step-up the battery voltage to power the system. Depending on the VIN value, it operates in one of three modes: charge mode, boost mode and sleep mode. In charge mode, the MP2635 supports a precision Li-ion or Li-polymer charging system for single-cell applications. In boost mode, MP2635 boosts the battery voltage to V_{SYS} to power higher-voltage systems. In sleep mode, the MP2635 stops charging or boosting and operates at a low current from the input or the battery to reduce power consumption when the IC isn't operating. The MP2635 monitors VIN to allow smooth transition between different modes of operation.

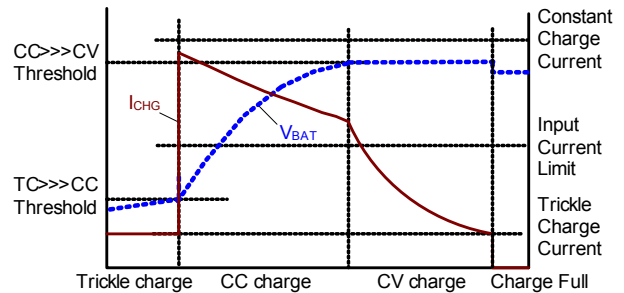
CHARGE MODE OPERATION

Charge Cycle (Trickle Charge → CC Charge → CV Charge)

In charge mode, the MP2635 has five control loops to regulate the input current, input voltage, charge current, charge voltage, and device junction temperature. It charges the battery in three phases: trickle current (TC), constant current (CC), and constant voltage (CV). While charging, all four loops are active but only one determines the IC behavior. Figure 11(a) shows a typical battery charge profile. The charger stays in TC charge mode until the battery voltage reaches a TC-to-CC threshold. Otherwise the charger enters CC charge mode. When the battery voltage rises to the CV-mode threshold, the charger operates in constant voltage mode. Figure 11(b) shows a typical charge profile when the input-current-limit loop dominates during the CC charge mode, and in this case the charge current exceeds the input current, resulting in faster charging than a traditional linear solution that is well-suited for USB applications.



a) Without input current limit



b) With input current limit

Figure 11: Typical Battery Charge Profile

Auto-Recharge

Once the battery charge cycle completes, the charger remains off. During this process, the system load may consume battery power, or the battery may self discharge. To ensure the battery will not go into depletion, a new charge cycle automatically begins when the battery voltage falls below the auto-recharge threshold and the input power is present. The timer resets when the auto-recharge cycle begins.

During the off state after the battery is fully charged, if the input power re-starts or the EN signal refreshes, the charge cycle will start and the timer will reset no matter what the battery voltage is.

Battery Over-Voltage Protection

The MP2635 has battery over-voltage protection. If the battery voltage exceeds the battery over-voltage threshold, (103.3% of the battery-full voltage), charging is disabled. Under this condition, an internal current source draws a current from the BATT pin to decrease the battery voltage and protect the battery.

Timer Operation in Charge Mode

The MP2635 uses an internal timer to terminate the charging. The timer remains active during the charging process. An external capacitor between TMR and GND programs the charge cycle duration.

If charging remains in TC mode beyond the trickle-charge time, $\tau_{\text{TRICKLE_TMR}}$, charging will terminate. The following determines the length of the trickle-charge period:

$$\tau_{\text{TRICKLE_TMR}} = 60 \text{ min s} \times \frac{C_{\text{TMR}} (\mu\text{F})}{0.1 \mu\text{F}} \times \frac{1\text{A}}{I_{\text{CHG}} (\text{A})} \quad (1)$$

The maximum total charge time is:

$$\tau_{\text{TOTAL_TMR}} = 6 \text{ Hours} \times \frac{C_{\text{TMR}} (\mu\text{F})}{0.1 \mu\text{F}} \times \frac{1\text{A}}{I_{\text{CHG}} (\text{A})} \quad (2)$$

Negative Temperature Coefficient (NTC) Input for Battery Temperature Monitoring

The MP2635 has a built-in NTC resistance window comparator, which allows the MP2635 to monitor the battery temperature via the battery-integrated thermistor. Connect an appropriate resistor from V_{SYS} to the NTC pin and connect the thermistor from the NTC pin to GND. The resistor divider determines the NTC voltage depending on the battery temperature. If the NTC voltage falls outside of the NTC window, the MP2635 stops charging. The charger will then restart if the temperature goes back into NTC window range.

Input-Current Limiting in Charge Mode

The MP2635 has a dedicated pin that programs the input-current limit. The current at ILIM is a fraction of the input current; the voltage at ILIM indicates the average input current of the switching regulator as determined by the resistor value between ILIM and GND. As the input current approaches the programmed input current limit, charge current is reduced to allow priority to system power.

Use the following equation to determine the input current limit threshold,

$$I_{\text{ILIM}} = \frac{40.5(\text{k}\Omega)}{R_{\text{ILIM}} (\text{k}\Omega)} (\text{A}) \quad (3)$$

Input Over-Current Protection

The MP2635 features input over-current protection (OCP): when the input current exceeds 3A, Q2 is controlled linearly to regulate the current. If the current still exceeds 3A after a 120 μs blanking time, Q2 will turn off. A fast off function turns off Q2 quickly when the input current exceeds 7A to protect both Q1 and Q2.

Input Voltage Regulation in Charge Mode

In charge mode, if the input power source is not sufficient to support both the charge current and system load current, the input voltage will decrease. As the input voltage approaches the programmed input voltage regulation value, charge current is reduced to allow priority of system power and maintain the input voltage avoid dropping further.

The input voltage can be regulated by a resistor divider from IN pin to REG pin to AGND according to the following expression:

$$V_{\text{REG}} = V_{\text{IN_R}} \times \frac{R5}{R3 + R5} (\text{V}) \quad (4)$$

Where the V_{REG} is the internal voltage reference, 1.2V.

Setting the Charge Current

The external sense resistors, RS1 and R_{ISET} , program the battery charge current, I_{CHG} . Select R_{ISET} based on RS1:

$$I_{\text{CHG}} (\text{A}) = \frac{70(\text{k}\Omega)}{R_{\text{ISET}} (\text{k}\Omega)} \times \frac{40(\text{mV})}{\text{RS1}(\text{m}\Omega)} \quad (5)$$

Where the 40mV is the charge current limiting reference.

Battery Short Protection

The MP2635 has two current limit thresholds. CC and CV modes have a peak current limit threshold of 3.6A, while TC mode has a current limit threshold of 1.5A. Therefore, the current limit threshold decreases to 1.5A when the battery voltage drops below the TC threshold. Moreover, the switching frequency also decreases when the BATT voltage drops to 40% of the charge-full voltage.

Thermal Foldback Function

The MP2635 implements thermal protection to prevent thermal damage to the IC and the surrounding components. An internal thermal sense and feedback loop automatically decreases the programmed charge current when the die temperature reaches 120°C. This function is called the charge-current-thermal foldback. Not only does this function protect against thermal damage, it can also set the charge current based

on requirements rather than worst-case conditions while ensuring safe operation. Furthermore, the part includes thermal shutdown protection where the ceases charging if the junction temperature rises to 150°C.

Full-Operation Indication

The MP2635 integrates indicators for the following conditions as shown in Table2.

Table 2: Indicator for Each Operation Mode

Operation		ACOK	CHG	BOOST
Charge Mode	In Charging	Low	Low	High
	End of Charge, charging disabled		High	
	NTC Fault, Timer Out		Blinking	
Boost Mode		High	High	Low
Sleep Mode, VCC absent		High	High	High